WIPE SAMPLING AND DOUBLE WASH/RINSE CLEANUP
AS RECOMMENDED BY
THE ENVIRONMENTAL PROTECTION AGENCY PCB SPILL CLEANUP POLICY

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Written By:
John H. Smith, Ph.D.
Chief, PCB Disposal Section
Chemical Regulation Branch
United States Environmental Protection Agency
Washington, D.C.
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I. WIPE SAMPLING ACCORDING TO THE PCB SPILL CLEANUP POLICY

Introduction:

This document was prepared following the publication of the PCB Spill Cleanup Policy in the Federal Register on April 2, 1987. The procedures were demonstrated by EPA PCB program technical staff at PCB Forum '87 and PCB Forum '88. These PCB forums were privately sponsored seminars discussing the requirements of the recently issued PCB Spill Cleanup Policy. The seminars were publicly announced and held in eight cities near the EPA Regional Offices.

The revisions and clarifications to the document include the addition of an Introduction heading, the addition of three paragraphs to the Background heading, and the amendment to item 4 in "An Example of a Wipe Sampling Procedure."

This document was revised and clarified because it did not clearly and completely state EPA's intentions in an area where details were essential, that is the original version of this document assumed that a gloved hand would apply the gauze with moderate pressure, but inadvertently this requirement was never explicitly stated in the example of the wipe sampling procedure. The gloved-hand application of the gauze might have been assumed since the gloves were to be discarded after each sample. The procedure clearly did not say to apply the gauze to the surface with forceps. The EPA demonstrations and discussions at the PCB Forums clearly emphasized the pressurized application of moistened cotton gauze to the surface with a gloved hand.

Background:

The PCB spill Cleanup Policy requires wipe sampling for the determination of surface levels of PCBs resulting from PCB spills onto hard, "smooth", surfaces such as metal, wood, concrete, plastic, and glass (see Tables 1 and 2). There are several activities surrounding a PCB spill cleanup where wipe sampling may be used: (a) site characterization; (b) interim evaluation of the progress of the cleanup; and (c) the final process to verify that the cleanup has met requirements of the PCB Spill Cleanup Policy.

Wipe sampling has a number of advantages. The most apparent advantage is that wipe sampling is probably the best way to determine smooth "impervious" surface concentrations. Wipe sampling is most effective in areas with relatively large, flat, easily accessible surfaces where an accidental and/or short time
exposure to PCBs has occurred. The surfaces which are sampled by wipe sampling in many cases will have been (or will be) cleaned by wiping or wiping-related activities.
Wipe sampling is best used in conjunction with statistical random sampling and/or area sampling techniques. Reduction in sampling errors for all kinds of sampling procedures can be accomplished by statistical selection of the smaller sampling sites selected to represent a larger area. Non-sampling errors may be reduced by maintaining consistency within the sampling activities; use of comprehensive quality control procedures and samples; and wherever possible, establishing a reference point for comparison.

Unfortunately, wipe sampling is not quantitative because of the fairly large variability in several component parts of sampling and the relative inefficiency of extraction of the analyte of interest from the wipes. Wipe sampling evaluation study results are known to vary widely, for example, when the same sampling is done (1) by different samplers; (2) on similarly contaminated surfaces having different textures or porosities; (3) using no solvent or solvents having different polarities; and (4) using different kinds of wiping material such as filter paper or cotton gauze.

When a decision is made to use wipe sampling, (1) it should be assumed that the results are not always reproducible; (2) extra care should be used to minimize the variability and optimize quantitation; and (3) even if representative sampling is employed, wipe sampling results can indicate residual levels substantially below true surface levels. In developing the PCB Spill Cleanup Policy, EPA has considered the advantages and disadvantages of wipe sampling and accordingly has established allowable residual PCB levels as measured by wipe sampling.

Since the objective of surface sampling is to remove PCB liquids and particles, which may be adhering to the surface, from the surface an aggressive sampling procedure is necessary. The aggressive sampling is appropriate since often the surfaces being samples have been aggressively cleaned and may drive residual PCBs into the surface. For determining the PCB surface concentrations on smooth surfaces, EPA recommends wipe sampling using cotton gauze as the wipe medium and using a gloved or doubly gloved hand to apply the wipe to the surface. This procedure requires changing into new/clean gloves between samples. EPA recognizes that there may be some transport of PCBs from the gauze to the surface of the gloves. However, this potential loss is considered more acceptable than the problems from the disadvantages of other wipe sampling procedures.

Procedures employing filter paper and/or glass fiber pads and application of these pads to surfaces by swabbing, dipping, or brushing with a pair of forceps are unacceptable. EPA
recognizes that this kind of wipe sampling technique may be
widely applied to address other kinds of surface sampling objectives. However, to meet EPA's PCB surface sampling objectives, these procedures are less efficient and less effective than hand wiping with the more absorbent cotton gauze.

Any compositing of wipe samples or sampling of areas larger than 100 cm² may not address the intent of PCB Spill Cleanup Policy verification sampling.

**Answers to Questions on Wipe Sampling Procedures:**

*Why is does it take so much care to wipe sample correctly?*

There is a considerable variability possible among wipe sampling results due to (a) the sampling technique of the sampler and (b) the efficiencies of removing PCBs from several matrices and placing the PCBs into several other matrices. Therefore it is important to reduce this variability to the maximum extent possible, so that in the event of a verification analysis by quality control samplers or government enforcement inspectors, similar wipe sampling results will be obtained for a clean site.

Two factors increase the probability of reducing errors introduced by the sampler's technique: consistency and quality control. Consistency is aided by proper training, easily understood sampling procedures, immediate availability of proper supplies, and whenever possible, using the same sampler to do all sampling at a particular site. Quality control procedures provide reference points and comparisons for the field sample results. When the analytical results from quality control samples indicate potential sampling and analysis problems, there is often sufficient time to reexamine field results. Quality control sampling can reduce or eliminate additional sampling and analysis start up and/or additional cleanup costs.

The reproducibility and efficiency of transferring residual PCBs from one place to another require that such residual PCBs must have a much greater affinity to partition, in one or more steps, from the place of origin to the ultimate destination. For all transfer steps, PCBs must exhibit a much greater propensity to be in the destination medium than in the medium of origin. There are several transfer steps in the process which starts from the removal of PCBs from the surface sampled and ends with the production of a PCB surface concentration by way of instrumental analysis.
The first of these transfer steps is removing residual PCBs from the surface to be sampled and transferring them into the sampling medium*. Gauze pads are sturdier, allow better surface to surface contact, and absorb more solvent (and more PCBs) than filter paper. Therefore, gauze pads are the absorbent/sampling medium of choice. Since PCBs are very soluble in organic solvents, organic solvent is used to moisten the gauze pads to ease the transport of PCBs from the sampled surface into the sampling media. Once the areas of where the spill occurred have been sampled (after cleanup) and the residual PCBs have been transported to the moistened gauze, then the gauze is air dried and stored/shipped for chemical analysis. The gauze is dried so as to facilitate transfer by organic solvent from the gauze to another medium during the laboratory extraction step.

In the extraction step the PCBs must be isolated from the gauze in a form amenable to the chemical analysis methods to be used. The PCBs now in the gauze are usually extracted into a solvent by repeated rinsing with and subsequent collection of organic solvent. The extraction solvent is removed from the PCBs by evaporation of the solvent prior to chemical analysis. The more volatile organic solvent evaporates and leaves the less volatile PCBs in a more concentrated solution for further treatment or instrumental analysis.

What is the best way to wipe sample for PCBs on smooth surfaces?

There are several steps in a wipe sampling procedure. The first step is to prepare the sampler for the sampling activity. The sampler may have to be advised of (through a briefing or a refresher course), or trained in, the objectives of the sampling program and the procedures to be used to accomplish those objectives.

Once advised of the objectives and sampling procedures, the sampler must either prepare or obtain the sampling plan and sampling materials. The sampler must know the exact sampling sites or know the exact procedure for selecting those sites. The sampling supplies must be sufficient in quantity and quality for all normally expected occurrences. Provisions should be also made for quality assurance samples, chain of custody forms, and shipping materials for storage.

* When PCB-contaminated office paper has been solvent rinsed, then wipe sampled and bulk sampled, some recent chemical analysis results indicate that the PCB concentration in the surface wipes is not the same as the concentration in the bulk samples. PCB levels in uncontaminated paper were used as a control. The difference in PCB levels in the wipe samples and bulk samples may
be explained by PCB migration into the paper either during cleanup to remove PCBs or during the wipe sampling step.
An important series of quality assurance measures taken before on-site sampling occurs may save considerable expense from collecting contaminated or unusable wipe samples. Sampler training can include practice sampling of surfaces spiked with PCB surrogate compounds, such as tri- and tetrachlorobenzenes to sharpen skills (a) in wiping thoroughly and consistently, and (b) avoiding cross contamination. In addition, before field sampling is conducted, method blanks can be used to verify that sampling equipment supplies and procedures do not introduce PCBs or analytical interferences to the wipe samples. Complete supplies for sampling should be cleaned, a fraction of the supplies sampled individually or through method blanks, and, if clean, the supplies should be protected against contamination or destruction while being transported to the sampling site and while at the sampling site before actual sampling occurs.

The sampler arrives at a sampling site and determines the exact location where the 100 square centimeter (cm$^2$) sample will be taken. The sample location may be marked or framed by a template. The sampler must be conscious of possibility of cross contamination during all stages of the sampling activity. All surfaces should be wiped with as uniform a pressure as possible. It is important to use the appropriate pressure to thoroughly wipe materials off the surface. Wiping proceeds from left to right in rows from the top to the bottom of the framed sampling area. The sampling area is wiped again with the same uniform pressure in columns from the top to the bottom from the left side to the right side of the entire framed area. It is not critical whether wiping starts at the top left or with rows first and then columns. The objective is to systematically, thoroughly, and consistently wipe the entire framed area twice, each time from a different direction and orientation.

Once the area has been wiped, the sampling gauze is allowed to air dry and is replaced in the sample vial. The sample vial is then labelled, the chain of custody filled out, and the sample prepared/stored for shipping.
Table 1

SUMMARY OF CLEANUP LEVELS
BASED ON THE EPA PCB SPILL CLEANUP POLICY

Requirements for Cleanup of Low-Concentration Spills
Which Involve Less Than One Pound PCBs by Weight
(Less Than 270 Gallons of Untested Mineral Oil
[Containing Less Than 500 ppm PCBs])

<table>
<thead>
<tr>
<th>Material</th>
<th>Cleanup Level</th>
</tr>
</thead>
<tbody>
<tr>
<td>Solid Surfaces (except for all indoor, residential surfaces other than vault areas)</td>
<td>Double washed/rinsed</td>
</tr>
<tr>
<td>All Indoor, Residential Surfaces Other Than Vault Areas</td>
<td>10 micrograms per 100 cm² by standard commercial wipe tests</td>
</tr>
<tr>
<td>Soil</td>
<td>Remove visible traces of the spill and soil within a one foot buffer of the visible traces</td>
</tr>
</tbody>
</table>
### Table 2

**SUMMARY OF CLEANUP LEVELS BASED ON THE EPA PCB SPILL CLEANUP POLICY**

**Requirements for Cleanup of High-Concentration Spills and Low-Concentration Spills Involving One Pound or More PCBs by Weight (270 Gallons or More of Untested Mineral Oil [Containing Less Than 500 ppm PCBs])**

<table>
<thead>
<tr>
<th>Location</th>
<th>Indoor (except vaults), and Outdoor High Contact</th>
<th>Indoor Vaults</th>
<th>Outdoor Low Contact Porous Surface Option</th>
<th>Soil</th>
</tr>
</thead>
<tbody>
<tr>
<td>Residential/Commercial/Rural</td>
<td>10 micrograms per 100 cm²</td>
<td>10 micrograms per 100 cm²</td>
<td>10 micrograms per 100 cm² plus encapsulation</td>
<td>10 ppm Plus a 10 Inch Cap</td>
</tr>
<tr>
<td>Restricted Access (Non-Sub-Station)</td>
<td>High Contact Surfaces</td>
<td>10 micrograms per 100 cm²</td>
<td>10 micrograms per 100 cm² plus Encapsulation</td>
<td>25 ppm</td>
</tr>
<tr>
<td></td>
<td>Low Contact Indoor Surfaces</td>
<td>10 micrograms per 100 cm²</td>
<td>100 micrograms per 100 cm² plus Encapsulation</td>
<td></td>
</tr>
<tr>
<td></td>
<td>Porous Surface Option</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Outdoor Low Contact Surfaces</td>
<td>100 micrograms per 100 cm²</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>Soil</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Outdoor Electrical Substations</td>
<td>Surfaces</td>
<td>100 micrograms per 100 cm²</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>
Soil

25 ppm or 50 ppm with Notice
Additional Wipe Sampling Information
(Contents)

1. An Example of a List of Wipe Sampling Supplies.
2. An Example of Sample Site Preparations.
3. An Example of a Wipe Sampling Procedure.
4. A Detailed Description of Quality Controls for Wipe Sampling Activities.
5. Wipe Sampling Quality Control Samples (Summary).
7. An Example of Procedures to Use When Cleaning Wipe Sampling Equipment.
An Example of a List of Wipe Sampling Supplies

Copy of Sampling Procedures and Study Objectives
Pen (Indelible Ink)
Pre-numbered Sample Labels
Tape to Cover Labels
Chain of Custody Forms
Screw Top Vials with Teflon Lined Caps
  These Vials Contain Pre-Cleaned 3" x 3" Surgical Gauze Pads
Teflon Squirt Bottle for Applying Solvent to Wipes and Washing
Solvent, preferably in a bottle with a volumetric delivery top
Graduated cylinder, when not using a volumetric delivery top
Disposable Gloves
Metal Ruler
Sampling Template
Forceps for Removing (Replacing) Gauze from (into) Vials
Disposable Wipes (for cleaning ruler)
Garbage Bags/Containers (for disposal of gloves and solid waste)
Funnel
Five Gallon Solvent Can for Disposal of Rinse Solvent
Shipping/Storage Containers for Samples
Sampling Site Description Forms with Optional Instant Print
Camera
An Example of Sample Site Preparations

At each sample site location:

- Mark the exact sample site with the template or a ruler.

- If the site is not easily marked with a template or ruler (an irregular non-planar surface), write a detailed description of the area sampled. A instant print photograph with the ruler included (for scale) is a very valuable descriptor.

- Prepare all necessary forms and sampling logs for entry of the sampling time, date, location, and other information describing the sampling at that particular site.

- Prepare all sampling equipment for sampling the site.
An Example of a Wipe Sampling Procedure

Assume that the exact sampling site has been marked.

1. With gloved hands, remove the cap from the sampling vial.

2. With the forceps, remove the gauze from the sampling vial.

3. From a solvent bottle, use the volumetric delivery device or fill a graduated cylinder with 5 milliliters of solvent to the gauze.

4. Immediately begin applying the gauze using a gloved hand and, applying pressure, wipe the marked area completely twice, from left to right and then from top to bottom.

5. Let the gauze air dry.

6. Fold the dry gauze (sampled side inward) and return it to the sample vial.

7. Cap the sample vial.

8. Remove and discard the gloves.

9. Label the vial and fill out sampling details on the sampling forms.

10. Fill out chain of custody forms and prepare the sample for storage and shipping.
A Detailed Description of Quality Controls for Wipe Sampling Activities

Several kinds of quality control (QC) samples should be used. Each kind of sample provides an indication of the reliability of a part of the sampling and analysis process.

It is better not to identify QC samples as such when submitting the QC samples to the analytical laboratory. It is best to randomly number all samples when submitting them to the analytical laboratory. The chemical analysis laboratory does not need to know sample descriptions except for matrix type or in the event of the presence of an unusually high concentration in the wipe. Specific identification of the QC samples will not be necessary since the concentration range in these samples should be in the normal operating range of the analytical instruments.

Vials refer to the glass vials containing sampling gauze.

1. Field Blanks - at least 5% of the total samples include at least two samples each from the following:

a. Ship unopened vials back for analysis.

b. With gloved hands, remove the cap from a sample vial for the estimated time (record this time) of normal wipe sampling, allow the gauze to air dry without applying it to any surface, and proceed with step 7 in the wipe sampling procedure.

c. Use the wipe sampling procedures to wipe some areas/surfaces near the sampling site but which are not expected to be contaminated.

2. Duplicates - at least 5% of total samples including at a minimum the designated samples from both the following groups:

a. Double wipe at least two sample sites, label which was the first wipe and which was the second wipe for each of the two sites, for each kind of surface sampled.

b. For at least two sample sites for each kind of surface sampled, wipe two adjacent identical or nearly identical areas. Clearly identify the samples as being adjacent to one another in the sample description forms.
3. Field Spikes - at least 5% of total samples including at a minimum the designated samples from each of the following groups for each kind of surface sampled. Clearly describe these samples on the sample description forms.

a. For two vials or more, remove each gauze and moisten as for sampling and spike each wet gauze with ten micrograms each of the kind of PCBs which was spilled, wipe a contaminated surface adjacent to a sampled surface as in 2b (above), let the gauze air dry, replace the gauze, and proceed with step 7 in the wipe sampling procedure.

b. For a second pair of vials or more, remove each gauze and moisten as for sampling, wipe a contaminated surface adjacent to a sampled surface as in 2b (above), after wipe sampling (but before air drying) spike each wet gauze with ten micrograms each of the kind of PCBs which was spilled, let the gauze air dry, replace the gauze in the vials, and proceed with step 7 in the wipe sampling procedure.

c. For a third pair of vials or more, spike sampling surfaces adjacent to another sampled surface as in 2b (above) with ten micrograms each of the kind of PCBs which was spilled and allow to air dry; remove each gauze and moisten as for sampling; wipe the surface; let the gauze air dry, replace the gauze in the vials; and proceed with step 7 in the wipe sampling procedure.
Wipe Sampling Quality Control Samples (Summary)

1. Field Blanks - At least two samples from each category
   a. For each spill site prepare the following blanks:
      i. Unopened sampling vials containing gauze
      ii. Remove gauze but do not use to wipe
   b. For each kind of surface, wipe an uncontaminated 100 cm$^2$ surface with a gauze as a blank surface

2. Duplicate Samples - At least 5% of total samples
   a. For each kind of surface at each spill site:
      i. Double wipe at least two sample sites
      ii. Side by side wipe at least two sample sites

3. Spiked Samples - At least 5% of total samples
   a. Wipe no less than two samples each for each kind of surface at each spill site. All are side by side paired samples. One sample for each pair is untreated, for the other sample:
      i. Spike gauze with 10 micrograms of PCBs, then wipe the 100 cm$^2$ area
      ii. Wipe the 100 cm$^2$ area first, then spike gauze with 10 micrograms of PCBs
      iii. Spike the 100 cm$^2$ site with 10 micrograms of PCBs, then wipe
An Example of Quality Assurance Procedures
Useful When Conducting Wipe Sampling Activities

1. Designate a person, not the sampler or chemical analyst, who is responsible for quality assurance and quality control including: training, preparation of sampling supplies, wipe sampling, sample preparation/extraction, chemical analysis, analytical data reduction, reporting of the sampling results, and conclusions drawn from the results.

2. Document the objectives of the wipe sampling and subsequent chemical analysis. Include performance requirements such as number of samples required, precision, accuracy, measurable deliverables, and schedules.

3. Develop a quality assurance plan which includes: the objectives; quality assurance/quality control procedures, audits, and schedules; persons responsible for all aspects of the sampling and chemical analysis efforts; references to all safety, training, sampling, and chemical analysis procedures; and corrective actions (including approximate times before corrective actions will occur) to be taken in the event that documented procedures cannot be or have not been followed.

4. Verify that staff doing sampling are the designated staff or suitably trained and informed replacements for the designated staff.

5. Verify that the sampling equipment and the sample gauze/vials are not going to introduce contamination into the samples.

6. Verify that sufficient quality control samples are taken and taken properly, that sampling objectives are met, and that chain of custody procedures are being followed.

7. Verify that sample extraction and chemical analysis occurs according to documented procedures. Assure that suitable and sufficient analytical quality control samples and reference standards are analyzed.

8. Verify that analytical data calculations are properly generated and the data are correctly associated with the proper samples.

9. Assure that conclusions based on the chemical analysis of the samples are in keeping with the sampling procedures and sample site locations.

10. Document quality assurance activities including: who did it, what was done, when it was done, where was it done, and why was it
done. Document and justify any deviations from documented procedures and policies.
An Example of
Procedures to Use When Cleaning Wipe Sampling Equipment

1. Using clean (or cleaned) disposable equipment is overall probably more cost-effective than cleaning and verifying that cleaned sampling equipment is free from PCBs. The second choice is not cleaning any equipment on or near the sampling site, but to have sufficient recleaned sampling equipment to completely sample a site. The least favorable situation is to clean sampling equipment for reuse at the same sampling site. If cleaning must be done at or near the sampling site, clean the sampling equipment as far from the actual site of cleanup/contaminations as possible.

2. Try to have sufficient clean materials on-site to completely sample a site (plus at least ten percent surplus for unforeseen accidents and blunders) so as not to have to clean any sampling equipment.

3. Use cleaning procedures which have been verified as effective previously. Good cleaning includes:

   - Washing with soapy water
   - Rinsing thoroughly with water
   - Rinsing three times thoroughly with distilled water
   - Rinsing with PCB-free organic solvent
   - Air drying for non-glass
   - Drying in a muffle furnace at 350°C for glass
   - Verification sampling and analysis of cleaned equipment
   - Protective packaging for shipment to the sampling site

4. The same kind of verification procedures should be used for new equipment as is used for equipment which has been cleaned:

   a. Selecting a statistical sample from the equipment. For lots having large numbers of units (such as sample bottles), a 5% or less proportion of the units may be sufficient. For equipment which comes in direct contact with contaminated surfaces (such as templates) a 10% sample may be more appropriate unless historical data have verified that a smaller proportion is sufficient.

   b. Rinsing "clean", dry equipment with the same amount of organic solvent as is used in the sampling procedure or more than sufficient solvent to completely cover and rinse off all contact (with the wipe sample, sampler, or the surface) surfaces of equipment. The rinseate is collected and treated as an extract from a sample gauze pad.

   c. The presence of detectable levels of PCBs indicate that
contamination is present and that the lot from which the verification sample(s) came must be either recleaned and reverified or disposed of appropriately.
II. DESCRIPTION OF DOUBLE WASH/RINSE

Introduction

The PCB Spill Cleanup Policy requires that low concentration spills of small amounts of PCBs on surfaces are to be removed by a double wash/rinse procedure. The objectives of the double wash/rinse are (1) to recognize the lesser hazard resulting from these small quantity spills and from the cleanup of such spills, and (2) to remove the easily removable PCB material thoroughly and quickly. It is also important not to redistribute PCBs or leave pieces of cleanup materials as a result of the cleanup procedure.

General Requirements for All Double Wash/Rinse Surfaces

For spills where there is still visible PCB-containing liquid present on the surface to be cleaned up, the double wash/rinse procedure first requires a pre-cleaning step. This step includes thoroughly wiping/mopping up the entire surface with absorbent paper or cloth material, such that there are no longer visible signs of the liquid present on the surface.

The double wash/rinse procedure called for in the cleanup of surfaces contaminated by small spills includes the two washing steps and two rinsing steps. The two washing and rinsing steps are slightly different depending on: (a) whether a contaminated surface was relatively clean before the spill, or (b) whether a surface was coated/covered with some sort of absorbent material, such as dust, dirt, grime, or grease.

Minimization of residual PCBs following the double wash/rinse procedure is facilitated by the proper selection and use of cleanup equipment. Scrubbers and the absorbent pads used in the double wash/rinse procedure shall not be dissolved by solvents or cleaners used. Scrubbers and absorbent pads shall not contain greater than 2 parts per million (weight per weight) PCBs. Washing scrubbers and absorbent pads shall not be reused. Rinsing scrubbers and absorbent pads may be reused as washing scrubbers or absorbent pads if necessary, but this is not recommended. All double wash/rinse cleaning/absorbent materials must remain intact (i.e. do not shred, crumble, or leave visible fragments on the surface) after the double wash/rinse operation.

During the double wash/rinse process, all washing and rinsing liquids/solvents must be contained, captured, and properly disposed of in accordance with local, state, and Federal regulations. Following use in the double wash/rinse process, all double wash/rinse equipment and absorbent materials must also be disposed
of in accordance with local state, and Federal regulations.
Summary of The Double Wash/Rinse Procedure

General
1. Use disposable cleaning materials which do not
   - dissolve or break apart
   - contain traces of PCBs.
2. Remove any visible PCB liquid before washing/rinsing.
3. Capture and contain washing/rinsing solutions.
4. Properly dispose of cleaning materials and solutions/liquids.

Specific
1. For surfaces not covered with dirt, dust, grime, grease or other potential absorbent of PCBs:

   WASH 1: Scrub with organic solvent and wipe up the solvent.
   RINSE 1: Wipe surface with moistened pad, wipe up with dry pad.
   WASH 2: Repeat WASH 1.
   RINSE 2: Repeat RINSE 1.

2. For surfaces covered with dirt, dust, grime, grease or other potential absorbent of PCBs:

   WASH 1: Scrub with detergent and water, dry.
   RINSE 1: Rinse with water, wipe with wet adsorbent pad, dry.
   WASH 2: Scrub with organic solvent and wipe up the solvent.
   RINSE 2: Wipe surface with moistened pad, wipe up with dry pad.
Detailed Requirements for the Double Wash/Rinse

1. Specific requirements for surfaces that do not appear dusty or grimy before a spill, such as glass, automobile surfaces, newly poured concrete, and desk tops:

   WASH 1.

   If there is no visible liquid or after having removed the visible liquid, cover the entire surface with organic solvent in which PCBs are soluble to at least 5% by weight. Contain and collect any runoff solvent for disposal. Scrub rough surfaces with a scrub brush or disposable scrubbing pad. Add solvent such that the surface is always very wet for one minute per square foot. Wipe smooth surfaces with a solvent-soaked, disposable absorbent pad for one minute per square foot. Any surface less than one square foot shall also be washed for one minute. Wipe, mop, and/or sorb the solvent onto absorbent material until no visible traces of the solvent remain.

   RINSE 1.

   Wipe the surface with an absorbent pad soaked with the same organic solvent with a solvent-soaked, disposable absorbent pad for one minute per square foot. Any surface less than one square foot shall also be washed for one minute. Immediately wipe/sop up the solvent on the surface with a dry absorbent.

   WASH 2.

   Repeat WASH 1.

   RINSE 2.

   Repeat RINSE 1.
Detailed Requirements for the Double Wash/Rinse (Continued)

2. Specific requirements for dirty, dusty, grimy, or greasy surfaces or surfaces having surface coverings of some other kind of sorbant materials (where the spill probably largely sorbed onto the materials on the surface):

**WASH 1.**

If there is no visible liquid or after having removed the visible liquid, cover the entire surface with concentrated or industrial strength detergent or non-ionic surfactant solution. Contain and collect all cleaning solutions for proper disposal. Scrub rough surfaces with a scrub brush or scrubbing pad, adding cleaning solution such that the surface is always very wet, for one minute per square foot. Wipe smooth surfaces with a cleaning solution-soaked disposable absorbent pad for one minute per square foot. Any surface less than one square foot shall also be washed for one minute. Mop up or absorb the residual cleaner solution and suds with an absorbent pad until the surface appears dry. This cleaning should remove any residual dirt, dust, grime, or other sorbant materials left on the surface following step one (above).

**RINSE 1.**

Rinse off the wash solution with one gallon of water per square foot and capture the rinse water. Mop up the wet surface until the surface appears dry.

**WASH 2.**

Next, cover the entire dry surface with organic solvent in which PCBs are soluble to at least 5% by weight. Scrub rough surfaces with a scrub brush or scrubbing pad adding solvent such that the surface is always very wet for one minute per square foot. Wipe smooth surfaces with a solvent-soaked, disposable absorbent pad for one minute per square foot. Any surface less than one square foot shall also be washed for one minute. Wipe, mop, and/or sorb the solvent onto absorbent material until no visible traces of the solvent remain.

**RINSE 2.**

Wipe the surface with an absorbent pad soaked with the
same organic solvent as in RINSE 1 (above) and immediately wipe up the solvent on the surface with a dry absorbent.